

## Metallized Polyphenylene-Sulphide (PPS) Capacitors in PCM 5 mm

### Special Features

- ~ Operating temperature up to 140° C
- ~ Self-healing
- ~ Low dissipation factor
- ~ Low dielectric absorption
- ~ Very constant capacitance value versus temperature
- ~ According to RoHS 2002/95/EC

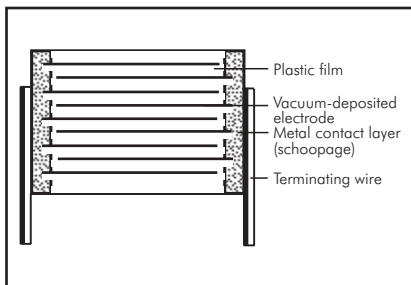
### Typical Applications

For general applications in high temperature circuits e.g.

- ~ By-pass
- ~ Blocking
- ~ Coupling and decoupling
- ~ Timing
- ~ Filtering
- ~ Oscillating circuits

### Construction

Dielectric:  
Polyphenylene-sulphide (PPS) film  
Capacitor electrodes:  
Vacuum-deposited  
Internal construction:



Encapsulation:  
Solvent-resistant, flame-retardent plastic case with epoxy resin seal, UL 94 V-0  
Terminations:  
Tinned wire.  
Marking:  
Colour: Red. Marking: White.  
Epoxy resin seal: Red

### Electrical Data

Capacitance range:  
0.01 µF to 1.0 µF (E12-values on request)  
Rated voltages:  
63 VDC, 100 VDC, 250 VDC, 400 VDC  
Capacitance tolerances:  
-20%, -10% (-5% available subject to special enquiry)  
Operating temperature range:  
-55+ C to +140+ C  
Climatic test category:  
55/140/56 in accordance with IEC  
Insulation resistance at +20+ C:

U <sub>r</sub>	U <sub>test</sub>	C ≤ 0.33 µF	0.33 µF < C ≤ 1.0 µF
63 VDC	50 V	≥ 1 x 10 <sup>4</sup> MΩ (mean value: 5 x 10 <sup>4</sup> MΩ)	≥ 3000 sec (MΩ x µF) (mean value: 6 000 sec)
≥100 VDC	100 V	≥ 1 x 10 <sup>4</sup> MΩ (mean value: 5 x 10 <sup>4</sup> MΩ)	-

Measuring time: 1 min.  
Dissipation factors at + 20) C: tan δ

at f	C ≤ 0.1 µF	0.1 µF < C ≤ 1.0 µF
1 kHz	≤ 15 x 10 <sup>-4</sup>	≤ 20 x 10 <sup>-4</sup>
10 kHz	≤ 20 x 10 <sup>-4</sup>	≤ 25 x 10 <sup>-4</sup>
100 kHz	≤ 50 x 10 <sup>-4</sup>	-

Maximum pulse rise time:

Capacitance µF	Pulse rise time V/µsec max. operation/test			
	63 VDC	100 VDC	250 VDC	400 VDC
0.01 ... 0.022	35/350	35/350	50/500	60/600
0.033 ... 0.068	20/200	20/200	40/400	50/500
0.1 ... 0.47	15/150	15/150	40/400	-
0.68 ... 1.0	12/120	12/120	-	-

for pulses equal to the rated voltage

### Mechanical Tests

Pull test on leads:  
10 N in direction of leads according to IEC 60068-2-21  
Vibration:  
6 hours at 10... 2000 Hz and 0.75 mm displacement amplitude or 10 g in accordance with IEC 60068-2-6  
Low air density:  
1kPa = 10 mbar in accordance with IEC 60068-2-13  
Bump test: 4000 bumps at 390 m/sec<sup>2</sup> in accordance with IEC 60068-2-29

### Packing

Available taped and reeled.  
Detailed taping information and graphs at the end of the catalogue.

For further details and graphs please refer to Technical Information.





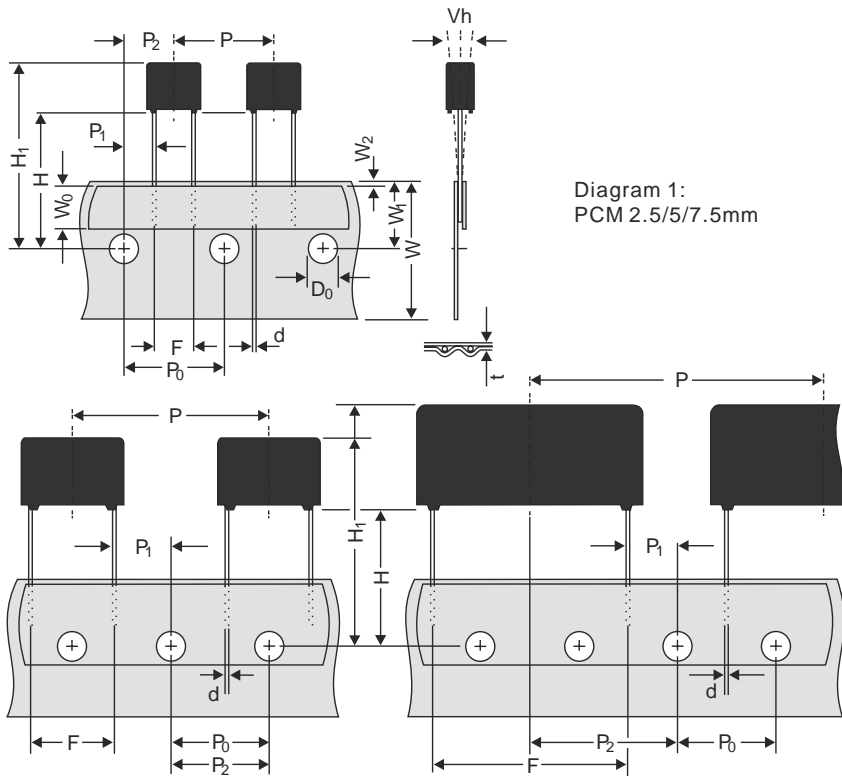


Diagram 2: PCM 10/15 mm

Diagram 3: PCM 22.5 and 27.5\*mm

\*PCM 27.5 tapping possible with two feed holes between components

Designation	Symbol	Dimensions for Radial Taping							
		PCM 2.5 tapping	PCM 5 tapping	PCM 7.5 tapping	PCM 10 tapping	PCM 15 tapping	PCM 22.5 tapping	PCM 27.5 tapping	
Carrier tape width	W	18.0 <sub>p0.5</sub>	18.0 <sub>p0.5</sub>	18.0 <sub>p0.5</sub>	18.0 <sub>p0.5</sub>	18.0 <sub>p0.5</sub>	18.0 <sub>p0.5</sub>	18.0 <sub>p0.5</sub>	
Hold-down tape width	W <sub>0</sub>	6.0 for hot-sealing adhesive tape	6.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	
Hole position	W <sub>1</sub>	9.0 <sub>p0.5</sub>	9.0 <sub>p0.5</sub>	9.0 <sub>p0.5</sub>	9.0 <sub>p0.5</sub>	9.0 <sub>p0.5</sub>	9.0 <sub>p0.5</sub>	9.0 <sub>p0.5</sub>	
Hold-down tape position	W <sub>2</sub>	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	
Feed hole diameter	D <sub>0</sub>	4.0 <sub>p0.2</sub>	4.0 <sub>p0.2</sub>	4.0 <sub>p0.2</sub>	4.0 <sub>p0.2</sub>	4.0 <sub>p0.2</sub>	4.0 <sub>p0.2</sub>	4.0 <sub>p0.2</sub>	
Pitch of component	P	12.7	12.7 <sub>p1.0</sub>	12.7 <sub>p1.0</sub>	25.4 <sub>p1.0</sub>	25.4 <sub>p1.0</sub>	38.1 <sub>p1.5</sub>	38.1 <sub>p1.5</sub> or 50.8 <sub>p1.5</sub>	
Feed hole pitch	P <sub>0</sub>	12.7 <sub>p0.3</sub> cumulative pitch error max. 1.0 mm/20 pitch	12.7 <sub>p0.3</sub> cumulative pitch error max. 1.0 mm/20 pitch	12.7 <sub>p0.3</sub> cumulative pitch error max. 1.0 mm/20 pitch	12.7 <sub>p0.3</sub> cumulative pitch error max. 1.0 mm/20 pitch	12.7 <sub>p0.3</sub> cumulative pitch error max. 1.0 mm/20 pitch	12.7 <sub>p0.3</sub> cumulative pitch error max. 1.0 mm/20 pitch	12.7 <sub>p0.3</sub> cumulative pitch error max. 1.0 mm/20 pitch	
Feed hole centre to lead	P <sub>1</sub>	5.1 <sub>p0.5</sub>	3.85 <sub>p0.7</sub>	2.6 <sub>p0.7</sub>	7.7 <sub>p0.7</sub>	5.2 <sub>p0.7</sub>	7.8 <sub>p0.7</sub>	5.3 <sub>p0.7</sub>	
Hole centre to component centre	P <sub>2</sub>	6.35 <sub>p1.3</sub>	6.35 <sub>p1.3</sub>	6.35 <sub>p1.3</sub>	12.7 <sub>p1.3</sub>	12.7 <sub>p1.3</sub>	19.05 <sub>p1.3</sub>	19.05 <sub>p1.3</sub>	
Feed hole centre to bottom edge of the component	H <sub>v</sub>	16.5 <sub>p0.3</sub> 18.5 <sub>p0.5</sub>	16.5 <sub>p0.3</sub> 18.5 <sub>p0.5</sub>	16.5 <sub>p0.5</sub> 18.5 <sub>p0.5</sub>	16.5 <sub>p0.5</sub> 18.5 <sub>p0.5</sub>	16.5 <sub>p0.5</sub> 18.5 <sub>p0.5</sub>	16.5 <sub>p0.5</sub> 18.5 <sub>p0.5</sub>	16.5 <sub>p0.5</sub> 18.5 <sub>p0.5</sub>	
Feed hole centre to top edge of the component	H <sub>1</sub>	H+H <sub>component</sub> ≤ H <sub>1</sub> 32.25 max.	H+H <sub>component</sub> ≤ H <sub>1</sub> 32.25 max.	H+H <sub>component</sub> ≤ H <sub>1</sub> 24.5 to 31.5	H+H <sub>component</sub> ≤ H <sub>1</sub> 25.0 to 31.5	H+H <sub>component</sub> ≤ H <sub>1</sub> 26.0 to 37.0	H+H <sub>component</sub> ≤ H <sub>1</sub> 30.0 to 43.0	H+H <sub>component</sub> ≤ H <sub>1</sub> 35.0 to 45.0	
Lead spacing at upper edge of carrier tape	F	2.5 <sub>p0.5</sub>	5.0 <sup>+0.8</sup> <sub>...0.2</sub>	7.5 <sub>p0.8</sub>	10.0 <sub>p0.8</sub>	15 <sub>p0.8</sub>	22.5 <sub>p0.8</sub>	27.5 <sub>p0.8</sub>	
Lead diameter	d	0.4 <sub>p0.05</sub>	0.5 <sub>p0.05</sub>	0.5 <sub>p0.05</sub> or 0.6 <sup>+0.06</sup> <sub>...0.05</sub>	0.5 <sub>p0.05</sub> or 0.6 <sup>+0.06</sup> <sub>...0.05</sub>	0.8 <sup>+0.08</sup> <sub>...0.05</sub>	0.8 <sup>+0.08</sup> <sub>...0.05</sub>	0.8 <sup>+0.08</sup> <sub>...0.05</sub>	
Component alignment	Dh	p 2.0 max.	p 2.0 max.	p 3.0 max.	p 3.0 max.	p 3.0 max.	p 3.0 max.	p 3.0 max.	
Total tape thickness	t	0.7	0.7 <sub>p0.2</sub>	0.7 <sub>p0.2</sub>	0.7 <sub>p0.2</sub>	0.7 <sub>p0.2</sub>	0.7 <sub>p0.2</sub>	0.7 <sub>p0.2</sub>	
Package (see also page 105)	v	ROLL/AMMO			AMMO				
		REEL P 360 max. P 30p1	B 52p2 B 58p2	depending on comp. dimensions	REEL P 360 max. P 30p1	52p2 B 58p2 or REEL P 500 max. P 25p1	54p2 B 60p2	depending on PCM and component dimensions	
Unit		see details page 107.							

v Please give CEH• dimensions and desired packaging type when ordering.  
 e Diameter of leads see General Data.  
 PCM 10 and PCM 15 can be crimped to PCM 7.5.  
 Position of components according to PCM 7.5 (sketch 217.0) 15.0 is possible

Please clarify customer-specific deviations with the manufacturer